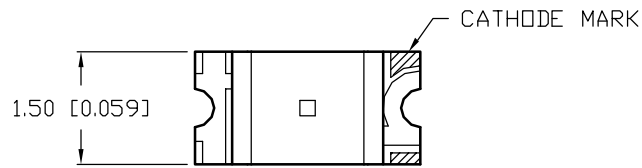
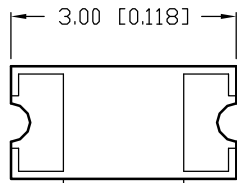
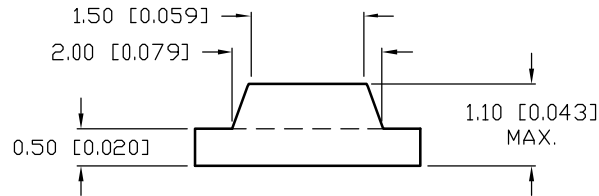


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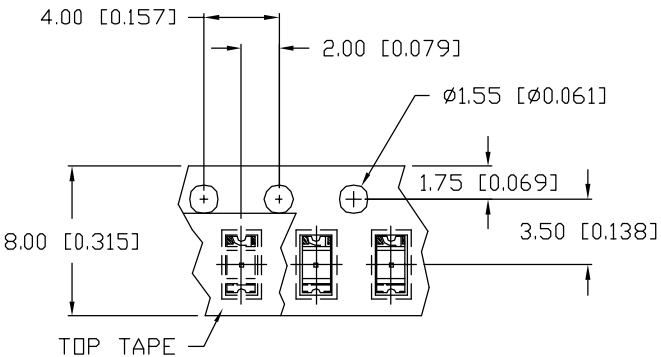
PART NUMBER		REV.
SML-LX1106SUGC-TR		A
REV.	E.C.N. NUMBER AND REVISION COMMENTS	DATE
A	E.C.N. #10967.	3.14.03



ANODE CATHODE

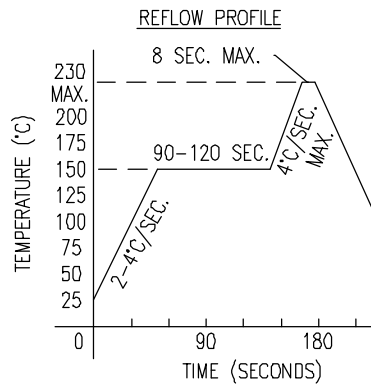
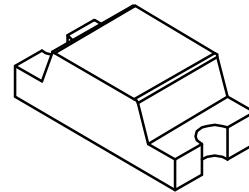


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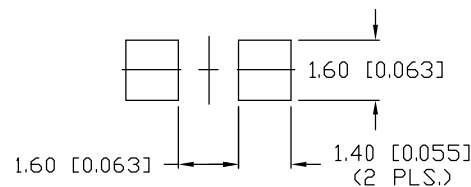


TOP TAPE  
TAPE FEED DIRECTION →

\*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.020), X.XX=±0.25 (±0.010), X.XXX=±0.127 (±0.005). LEAD SIZE=±0.05 (0.002), LEAD LENGTH=±0.75 (±0.030). MIN= <sup>+DECIMAL PRECISION</sup> -0.00 MAX= <sup>+0.00</sup> -DECIMAL PRECISION



RECOMMENDED SOLDER PAD LAYOUT



ELECTRO-OPTICAL CHARACTERISTICS  $T_A=25^\circ\text{C}$   $I_f=20\text{mA}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		574		nm	
FORWARD VOLTAGE		2.2	2.6	$V_f$	
REVERSE VOLTAGE	5.0			$V_r$	$I_f=100\mu\text{A}$
AXIAL INTENSITY		45		mcd	$I_f=20\text{mA}$
VIEWING ANGLE		140		$2x$ theta	
EMITTED COLOR:	GREEN				
EPOXY LENS FINISH:	WATER CLEAR				

LIMITS OF SAFE OPERATION AT 25°C

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	160	mA
STEADY CURRENT	25	mA
POWER DISSIPATION	100	mW
DERATE FROM 25°C	-1.2	mW/°C
OPERATING TEMP.	-30 TO +85	°C
STORAGE TEMP.	-40 TO +85	°C

\*  $t < 10\mu\text{s}$

NOTES:

1. THE POLARITY MARK IS ORIENTED TOWARDS THE TAPE SPROCKET HOLE.

**CAUTION: MOISTURE SENSITIVE DEVICE**  
PER JEDEC LEVEL 4 STANDARDS

UNCONTROLLED DOCUMENT

REV.	PART NUMBER
A	SML-LX1106SUGC-TR

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3mm x 1.5mm SURFACE MOUNT LED,  
574nm SUPER ULTRA GREEN LED,  
WATER CLEAR LENS, TAPE AND REEL.

**RELIABILITY NOTE**  
OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

DRAWN BY:	CHECKED BY:	APPROVED BY:	DATE:
BC			1.8.01
			PAGE: 1 OF 1
			SCALE: N/A